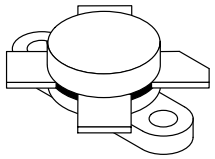
The RF Line
NPN Silicon RF Power Transistor

Designed for 12.5 volt low band VHF large–signal power amplifier applications in commercial and industrial FM equipment.

- Specified 12.5 V, 50 MHz Characteristics —
  Output Power = 70 W
  Minimum Gain = 11 dB
  Efficiency = 50%
- Load Mismatch Capability at High Line and RF Overdrive

MRF492

**70 W, 50 MHz
RF POWER
TRANSISTOR
NPN SILICON**



CASE 211–11, STYLE 1

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	18	Vdc
Collector–Base Voltage	V_{CBO}	36	Vdc
Emitter–Base Voltage	V_{EBO}	4.0	Vdc
Collector Current — Continuous	I_C	20	Adc
Total Device Dissipation @ T_C = 25°C (1) Derate above 25°C	P_D	250 1.43	Watts W/°C
Storage Temperature Range	T_{stg}	–65 to +150	°C

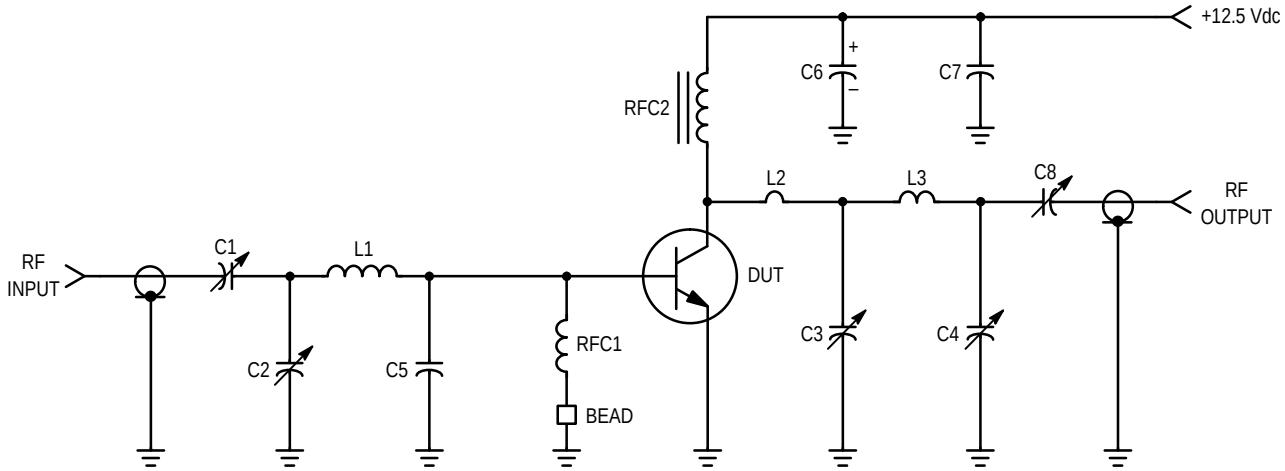
THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case (2)	$R_{\theta JC}$	0.7	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage (I_C = 100 mAdc, I_B = 0)	$V_{(BR)CEO}$	18	—	—	Vdc
Collector–Emitter Breakdown Voltage (I_C = 50 mAdc, V_{BE} = 0)	$V_{(BR)CES}$	36	—	—	Vdc
Emitter–Base Breakdown Voltage (I_E = 10 mAdc, I_C = 0)	$V_{(BR)EBO}$	4.0	—	—	Vdc
Collector Cutoff Current (V_{CE} = 13.6 Vdc, V_{BE} = 0)	I_{CES}	—	—	20	mAdc
ON CHARACTERISTICS					
DC Current Gain (I_C = 5.0 Adc, V_{CE} = 5.0 Vdc)	h_{FE}	10	—	150	—
DYNAMIC CHARACTERISTICS					
Output Capacitance (V_{CB} = 15 Vdc, I_E = 0, f = 1.0 MHz)	C_{ob}	—	275	450	pF
FUNCTIONAL TESTS					
Common–Emitter Amplifier Power Gain (V_{CC} = 12.5 Vdc, P_{out} = 70 W, f = 50 MHz)	G_{PE}	11	13	—	dB
Collector Efficiency (V_{CC} = 12.5 Vdc, P_{out} = 70 W, f = 50 MHz)	η	50	—	—	%

NOTES:
1. These devices are designed for RF operation. The total device dissipation rating applies only when the devices are operated as RF amplifiers.
2. Thermal Resistance is determined under specified RF operating conditions by infrared measurement techniques.



C1, C8 — 9.0–180 pF, Arco 463
C2, C3, C4 — 80–480 pF, Arco 466
C5 — 1000 pF, 350 V, Unelco
C6 — 10 μF, 25 Vdc
C7 — 0.01 μF, Ceramic
RFC1 — 10 μH Molded Choke
RFC2 — 12 Turns, #16 AWG, Enameled Wire Closewound on a 2.0 W Carbon Resistor
L1 — 2 Turns, #18 AWG Enameled Wire, 0.4″ ID, 0.15″ Long
L2 — Loop, #12 AWG Wire, 0.6″ High, 0.4″ Wide
L3 — 2 Turns, #12 AWG Wire, ID 0.4″, 0.25″ Long
Bead — Ferrite Bead Ferroxcube #56–590–65/3B

Figure 1. 50 MHz Test Circuit

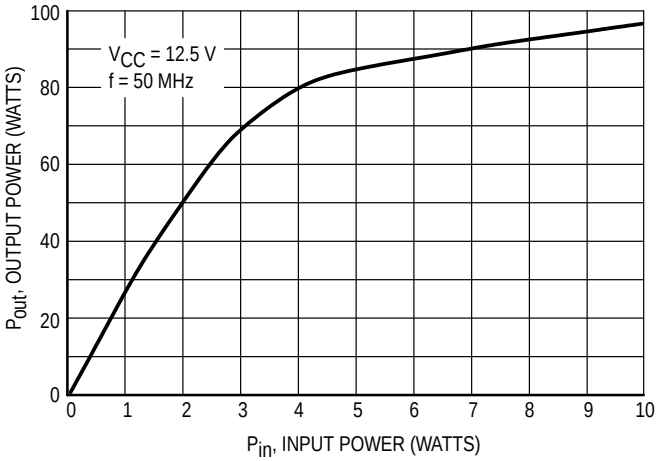


Figure 2. Output Power versus Input Power

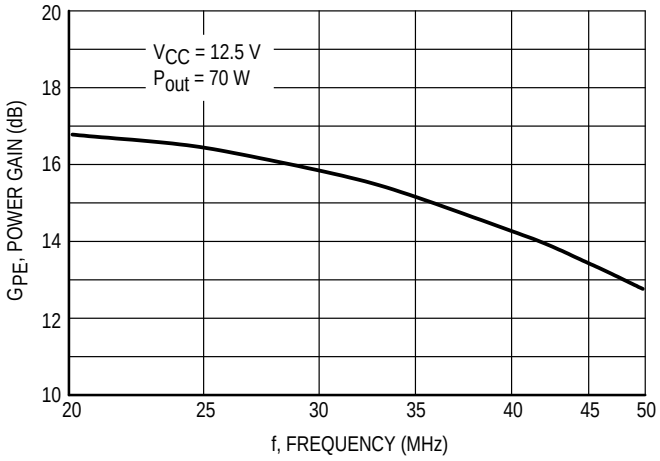


Figure 3. Power Gain versus Frequency

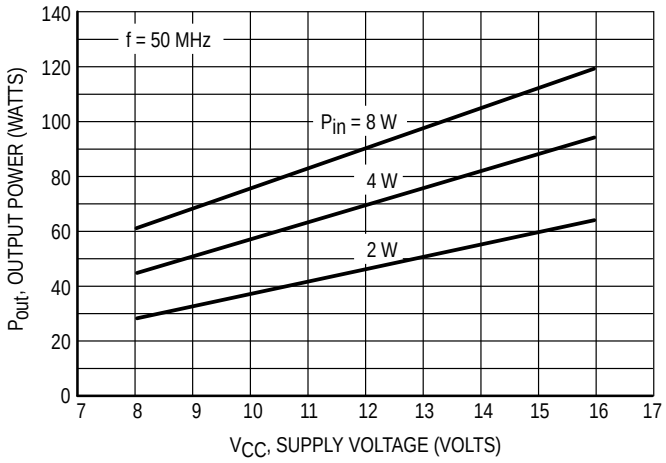
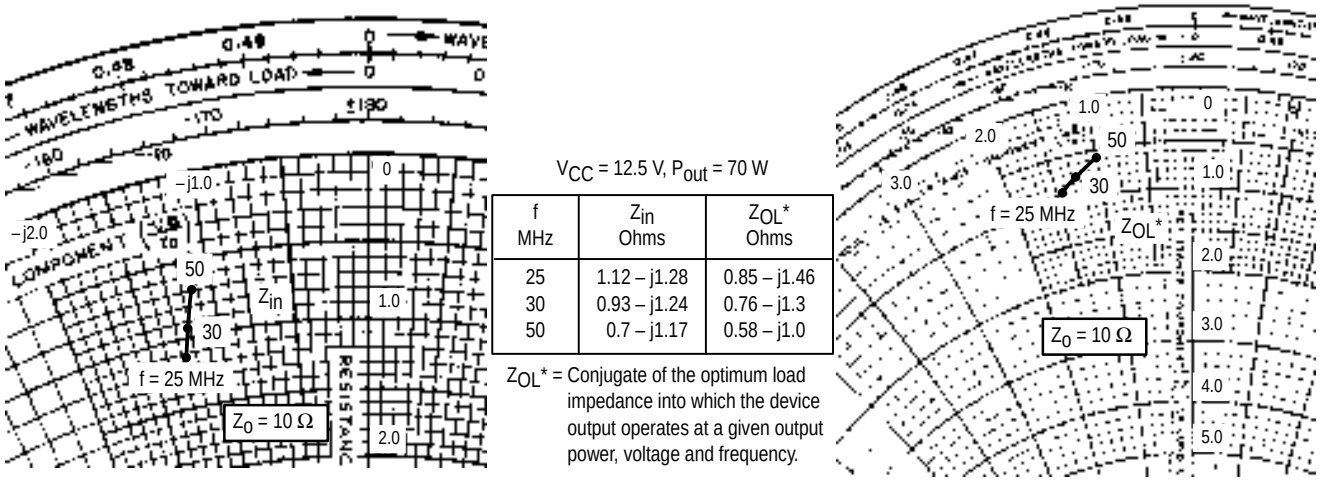


Figure 4. Output Power versus Supply Voltage

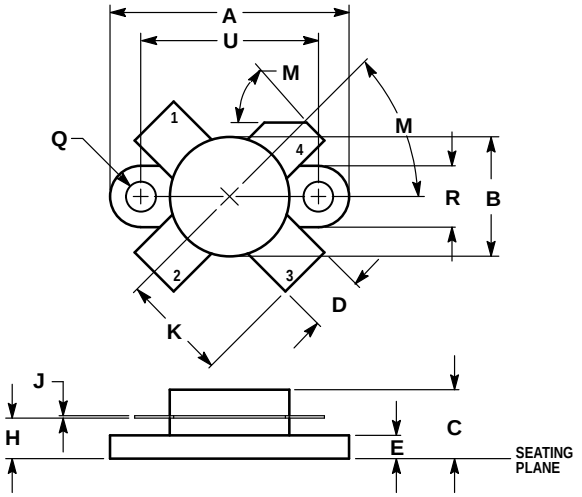


f MHz	Z_{in} Ohms	Z_{OL}* Ohms
25	1.12 – j1.28	0.85 – j1.46
30	0.93 – j1.24	0.76 – j1.3
50	0.7 – j1.17	0.58 – j1.0

Z_{OL}* = Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage and frequency.

Figure 5. Series Equivalent Input/Output Impedances

PACKAGE DIMENSIONS



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.960	0.990	24.39	25.14
B	0.465	0.510	11.82	12.95
C	0.229	0.275	5.82	6.98
D	0.216	0.235	5.49	5.96
E	0.084	0.110	2.14	2.79
H	0.144	0.178	3.66	4.52
J	0.003	0.007	0.08	0.17
K	0.435	—	11.05	—
M	45 °NOM		45 °NOM	
Q	0.115	0.130	2.93	3.30
R	0.246	0.255	6.25	6.47
U	0.720	0.730	18.29	18.54

STYLE 1:
PIN 1. EMITTER
2. BASE
3. EMITTER
4. COLLECTOR

CASE 211–11
ISSUE N

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